



# THE DATASHEET OF IRS2452AM



### Features

- 2 channel integrated analog input Class D audio amplifier driver
- Differential or single-ended input
- Versatile protection control enabling latched, non-latched, or host controlled shutdown function
- Programmable over current protection
- Programmable dead-time generation
- External thermal sensor input
- Click noise reduction
- Under voltage protection
- High noise immunity

### Product Summary

|   |                         |
|---|-------------------------|
| Topology                                  | Half-Bridge/Full-Bridge |
| $V_{\text{OFFSET (max)}}$                 | +/- 200 V               |
| $I_{\text{O+}} & I_{\text{O-}}$ (typical) | 0.5 A & 0.6 A           |
| Selectable deadtime                       | 45/65/85/105 ns         |
| DC offset                                 | <18 mV                  |
| OC protection delay                       | 500 ns (max)            |
| Shutdown propagation delay                | 250 ns (max)            |
| Error amplifier open loop gain            | >60 dB                  |

### Package Options



### Ordering Information

| Base Part Number | Package Type | Standard Pack |          | Orderable Part Number |
|------------------|--------------|---------------|----------|-----------------------|
|                  |              | Form          | Quantity |                       |
| IRS2452AM        | MLPQ 32 7x7  | Tape and Reel | 3000     | IRS2452AM             |

## Description

The IRS2452AM integrates two channels of high voltage, high performance Class D audio amplifier drivers with PWM modulators and protections. In conjunction with external MOSFET, the IRS2452AM forms a complete 2 channel Class D audio amplifier. The IRS2452AM is designed with floating analog inputs and protection control interface pins convenient for half bridge applications. High and low side MOSFET are protected from over current conditions by a programmable over current protection. Essential elements of PWM modulator section allow flexible system design. A small MLPQ 7x7mm package enhances the benefit of smaller size of Class D topology. The IRS2452AM is a lead-free, ROHS compliant.

## Qualification Information<sup>†</sup>

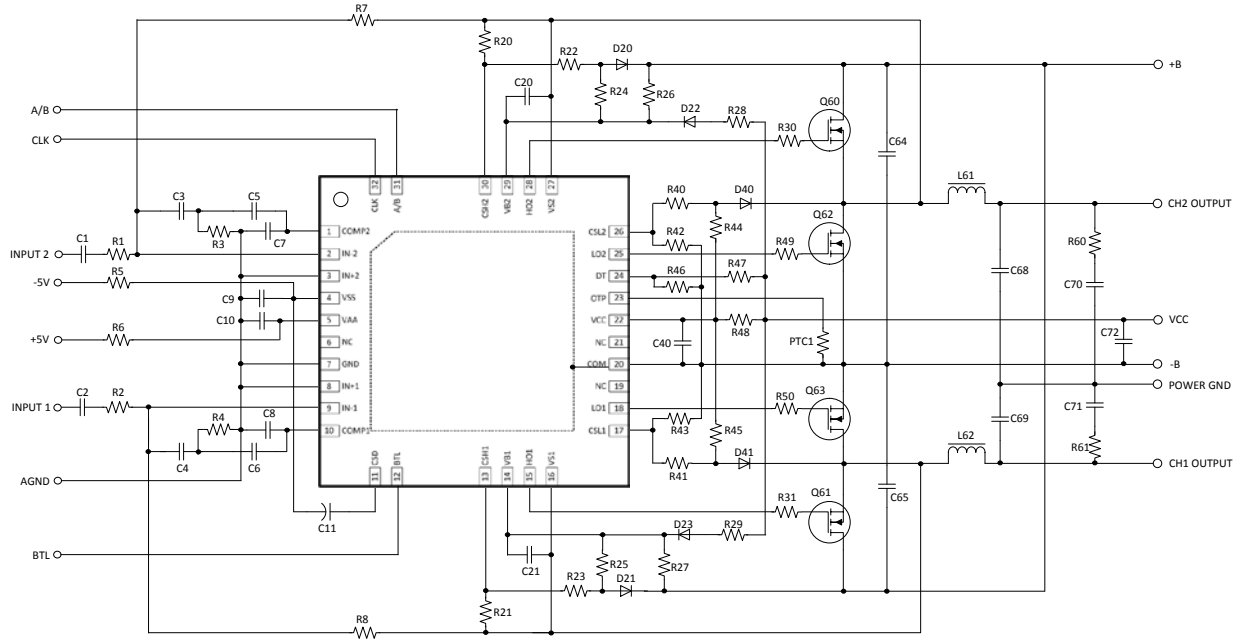
|                                   |                            |   |
|-----------------------------------|----------------------------|---|
| <b>Qualification Level</b>        |                            | Industrial <sup>††</sup>  |
|                                   |                            | Comments: This family of ICs has passed JEDEC's Industrial qualification. IR's Consumer qualification level is granted by extension of the higher Industrial level. |
| <b>Moisture Sensitivity Level</b> |                            | MSL2 <sup>†††</sup> , 260°C<br>(per IPC/JEDEC J-STD-020)  |
| <b>ESD</b>                        | <b>Machine Model</b>       | Class B<br>(per JEDEC standard EIA/JESD22-A115)   |
|                                   | <b>Human Body Model</b>    | Class 1B<br>(per EIA/JEDEC standard JESD22-A114)  |
|                                   | <b>Charge Device Model</b> | Class 0B<br>(per EIA/JEDEC standard JESD22-C101)  |
| <b>IC Latch-Up Test</b>           |                            | Class I, Level A<br>(per JESD78)  |
| <b>RoHS Compliant</b>             |                            | Yes   |

† Qualification standards can be found at Infineon web site <http://www.infineon.com/product-info/reliability/>

†† Higher qualification ratings may be available should the user have such requirements. Please contact your Infineon Technology sales representative for further information.

††† Higher MSL ratings may be available for the specific package types listed here. Please contact your Infineon Technology sales representative for further information.

## Typical Connection Diagram



### Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM; all currents are defined positive into any lead. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions.

| Symbol       | Definition   | Min.                   | Max.           | Units |
|--------------|--|------------------------|----------------|-------|
| $V_{Bn}$     | High side floating supply voltage                                | -0.3                   | 415            | V     |
| $V_{Sn}$     | High side floating supply voltage <sup>††</sup> , n=1-2          | $V_{Bn} - 15$          | $V_{Bn} + 0.3$ | V     |
| $V_{Hon}$    | High side floating output voltage, n=1-2                         | $V_{Sn} - 0.3$         | $V_{Bn} + 0.3$ | V     |
| $V_{CSHn}$   | CSH pin input voltage, n=1-2                                     | $V_{Sn} - 0.3$         | $V_{Bn} + 0.3$ | V     |
| $V_{CC}$     | $V_{CC}$ low side fixed supply voltage <sup>††</sup>             | -0.3                   | 15.5           | V     |
| $V_{Lon}$    | Low side output voltage, n=1-2                                   | -0.3                   | $V_{CC} + 0.3$ | V     |
| $V_{AA}$     | Floating input positive supply voltage <sup>††</sup>             | (See $I_{AAZ}$ )       | 210            | V     |
| $V_{SS}$     | Floating input negative supply voltage <sup>††</sup>             | -1<br>(See $I_{SSZ}$ ) | $V_{AA} + 0.3$ | V     |
| $V_{GND}$    | Floating input supply ground voltage                             | $V_{SS} - 0.3$         | $V_{AA} + 0.3$ | V     |
| $I_{IN-n}$   | Inverting input current <sup>†</sup> , n=1-2                     | -                      | $\pm 3$        | mA    |
| $V_{CSD}$    | SD pin input voltage   | $V_{GND} - 0.3$        | $V_{AA} + 0.3$ | V     |
| $V_{COMPn}$  | COMP pin input voltage, n=1-2                                    | $V_{SS} - 0.3$         | $V_{AA} + 0.3$ | V     |
| $V_{CLK}$    | CLK pin input voltage  | $V_{SS} - 0.3$         | $V_{AA} + 0.3$ | V     |
| $V_{BTL}$    | BTL pin input voltage  | $V_{SS} - 0.3$         | $V_{AA} + 0.3$ | V     |
| $V_{AB}$     | A/B pin input voltage  | $V_{SS} - 0.3$         | $V_{AA} + 0.3$ | V     |
| $V_{DT}$     | DT pin input voltage   | -0.3                   | $V_{CC} + 0.3$ | V     |
| $V_{OTP}$    | OTP pin input voltage  | -0.3                   | $V_{CC} + 0.3$ | V     |
| $V_{CSLn}$   | CSL pin input voltage, n=1-2                                     | -0.3                   | $V_{CC} + 0.3$ | V     |
| $I_{AAZ}$    | Floating input positive supply zener clamp current <sup>††</sup> | -                      | 10             | mA    |
| $I_{CCZ}$    | Low side $V_{CC}$ supply zener clamp current <sup>††</sup>       | -                      | 10             | mA    |
| $I_{BSZn}$   | Floating supply zener clamp current <sup>††</sup> , n=1-2        | -                      | 10             | mA    |
| $dV_{Sn}/dt$ | Allowable $V_s$ voltage slew rate, n=1-2                         | -                      | 50             | V/ns  |
| $dV_{SS}/dt$ | Allowable $V_{ss}$ voltage slew rate <sup>†††</sup>              | -                      | 50             | V/ms  |

**Absolute Maximum Ratings (Cont'd)**

| Symbol            | Definition   | Min. | Max. | Units |
|-------------------|--|------|------|-------|
| Pd                | Maximum power dissipation @ $T_A \leq +25^\circ\text{C}^{\dagger\dagger\dagger}$ | -    | 6    | W     |
| Rth <sub>JA</sub> | Thermal resistance, Junction to ambient <sup>†††</sup>                           | -    | 20   | °C/W  |
| T <sub>J</sub>    | Junction Temperature   | -    | 150  | °C    |
| T <sub>S</sub>    | Storage Temperature  | -55  | 150  | °C    |
| T <sub>L</sub>    | Lead temperature (Soldering, 10 seconds)   | -    | 300  | °C    |

† IN-1 and IN-2 contain clamping diode to GND.

†† VAA-VSS, VCC-COM, VB1-VS1 and VB2-VS2 contain internal shunt zener diodes. Note that the voltage ratings of these can be limited by the clamping current.

††† For the rising and falling edges of step signal of 10V. VSS=15V to 200V.

†††† According to JESD51-5. JEDEC still air chamber.

## Recommended Operating Conditions

For proper operation, the device should be used within the recommended conditions below. The  $V_S$  and COM offset ratings are tested with supplies biased at  $V_{AA}-V_{SS}=10V$ ,  $V_{CC}=12V$ , COM2=COM and  $V_B-V_S=12V$ . All voltage parameters are absolute voltages referenced to COM; all currents are defined positive into any lead.

| Symbol       | Definition  | Min.                      | Max.                      | Units |
|--------------|---|---------------------------|---------------------------|-------|
| $V_{Bn}$     | High side floating supply absolute voltage, n=1-2                     | $V_{Sn} + 10$             | $V_{Sn} + 14$             | V     |
| $V_{Sn}$     | High side floating supply offset voltage                              | (Note1)                   | 400                       | V     |
| $V_{AA}$     | Floating input supply voltage   | $V_{SS} + 4.5$            | $V_{SS} + 15$             | V     |
| $I_{AAZ}$    | Floating input positive supply zener clamp current                    | 1                         | 11                        | mA    |
| $V_{SS}$     | Floating input supply absolute voltage                                | 0                         | 200                       | V     |
| $V_{Hon}$    | High side floating output voltage, n=1-2                              | $V_S$                     | $V_B$                     | V     |
| $V_{CC}$     | Low side fixed supply voltage   | 10                        | 14                        | V     |
| $V_{Lon}$    | Low side output voltage, n=1-2  | 0                         | $V_{CC}$                  | V     |
| $V_{GND}$    | GND pin input voltage   | $V_{SS}^{(Note2)}$        | $V_{AA}^{(Note2)}$        | V     |
| $V_{IN-n}$   | Inverting input voltage, n=1-2  | $V_{GND} - 0.5^{(Note2)}$ | $V_{GND} + 0.5^{(Note2)}$ | V     |
| $V_{CSD}$    | CSD pin input voltage   | $V_{GND}$                 | $V_{AA}$                  | V     |
| $V_{COMPn}$  | COMP pin input voltage, n=1-2   | $V_{SS}$                  | $V_{AA}$                  | V     |
| $C_{COMPn}$  | COMP pin phase compensation capacitor to GND, n=1-2                   | 2.2                       | -                         | nF    |
| $V_{CLK}$    | CLK pin input voltage   | $V_{GND}$                 | $V_{AA}$                  | V     |
| $V_{BTL}$    | BTL pin input voltage   | $V_{SS}$                  | $V_{AA}$                  | V     |
| $V_{AB}$     | A/B pin input voltage   | $V_{SS}$                  | $V_{AA}$                  | V     |
| $V_{DT}$     | DT pin input voltage  | 0                         | $V_{CC}$                  | V     |
| $V_{OTP}$    | OTP pin input voltage   | 0                         | $V_{CC}$                  | V     |
| $V_{CSHn}$   | CSH pin input voltage, n=1-2  | $V_{Sn}$                  | $V_{Bn}$                  | V     |
| $V_{CSLn}$   | CSL pin input voltage, n=1-2  | 0                         | $V_{CC}$                  | V     |
| $dV_{SS}/dt$ | Allowable $V_{SS}$ voltage slew rate upon power-up <sup>(Note3)</sup> | -                         | 50                        | V/ms  |
| $f_{SW}$     | Switching frequency   | -                         | 800                       | kHz   |
| $f_{CLK}$    | CLK frequency <sup>(Note4)</sup>                                      | -                         | 800                       | kHz   |
| $T_A$        | Ambient Temperature   | -40                       | 125                       | °C    |

(Note 1) Logic operational for  $V_{Sn}$  equal to  $-5V$  to  $+400V$ . Logic state held for  $V_{Sn}$  equal to  $-5V$  to  $-V_{BSn}$ .

(Note 2) GND input voltage is limited by IIN-n.

(Note 3)  $V_{SS}$  ramps up from 0V to 200V.

(Note 4) The CLK input frequency needs to be within +/-10% of self-oscillating frequency in order to synchronize PWM in a typical self-oscillating application.

### Electrical Characteristics

$V_{CC}=V_{BS1}=V_{BS2}=V_{DT}=12V$ ,  $V_{SS}=V_{S1}=V_{S2}=COM=0V$ ,  $V_{GND}=5V$ ,  $V_{AA}=V_{BTL}=V_{AB}=10V$ ,  $C_L=1nF$  and  $T_A=25^\circ C$  unless otherwise specified.

| Symbol                           | Definition  | Min  | Typ  | Max  | Units   | Test Conditions                          |
|----------------------------------|---|------|------|------|---------|--|
| <b>Low Side Supply</b>           |   |      |      |      |         |  |
| $UV_{CC+}$                       | Vcc supply UVLO positive threshold                                | 8.4  | 8.9  | 9.4  | V       |  |
| $UV_{CC-}$                       | Vcc supply UVLO negative threshold                                | 8.2  | 8.7  | 9.2  | V       |  |
| $UV_{CCHYS}$                     | $UV_{CC}$ hysteresis  | -    | 0.2  | -    | V       |  |
| $I_{QCC}$                        | Low side quiescent current  | -    | -    | 6    | mA      | $V_{DT}=V_{CC}$                          |
| $V_{CLAMPL}$                     | Low side zener diode clamp voltage                                | 14.7 | 15.3 | 16.2 | V       | $I_{CC}=5mA$                             |
| <b>High Side Floating Supply</b> |   |      |      |      |         |  |
| $UV_{BS+n}$                      | High side well UVLO positive threshold, n=1-2                     | 8.0  | 8.5  | 9.0  | V       |  |
| $UV_{BS-n}$                      | High side well UVLO negative threshold, n=1-2                     | 7.8  | 8.3  | 8.8  | V       |  |
| $UV_{BSHYSn}$                    | $UV_{BS}$ hysteresis, n=1-2                                       | -    | 0.2  | -    | V       |  |
| $I_{QBSn}$                       | High side quiescent current, n=1-2                                | -    | -    | 1    | mA      |  |
| $I_{LKHn}$                       | High to Low side leakage current, n=1-2                           | -    | -    | 50   | $\mu A$ | $V_{Bn}=V_{Sn}=400V$                     |
| $V_{CLAMPHn}$                    | High side zener diode clamp voltage, n=1-2                        | 14.7 | 15.3 | 16.2 | V       | $I_{BSn}=5mA$                            |
| <b>Floating Input Supply</b>     |   |      |      |      |         |  |
| $UV_{AA+}$                       | $V_{AA}$ floating supply UVLO positive threshold from $V_{SS}$    | 8.2  | 8.7  | 9.2  | V       | GND pin floating                         |
| $UV_{AA-}$                       | $V_{AA}$ floating supply UVLO negative threshold from $V_{SS}$    | 7.7  | 8.2  | 8.7  | V       | GND pin floating                         |
| $UV_{AAHYS}$                     | $UV_{AA}$ hysteresis  | -    | 0.5  | -    | V       | GND pin floating                         |
| $I_{QAASD}$                      | Floating Input positive quiescent supply current in shutdown mode | -    | 2.5  | 4    | mA      | $V_{CSD}=V_{GND}$                        |
| $I_{QAA0}$                       | Floating Input positive quiescent supply current, positive input  | -    | 8    | 11   | mA      | $V_{IN-}=V_{SS}+5.2V$                    |
| $I_{QAA1}$                       | Floating Input positive quiescent supply current, negative input  | -    | 5    | 8    | mA      | $V_{IN-}=V_{SS}+4.8V$                    |
| $I_{QAAST}$                      | Floating Input positive quiescent supply current in start-up mode | -    | 6    | 8    | mA      | $V_{CSD}=V_{GND}+2.5V$                   |
| $I_{QAABTL}$                     | Floating Input positive quiescent supply current, negative input  | -    | 5    | 8    | mA      | $V_{IN-}=V_{SS}+4.8V$ ,<br>$V_{BTL}=GND$ |
| $I_{LKM}$                        | Floating input side to Low side leakage current                   | -    | -    | 50   | $\mu A$ | $V_{AA}=V_{SS}=V_{GND}=100V$             |
| $V_{CLAMPM}$                     | Floating supply zener diode clamp voltage                         | 14.7 | 15.3 | 16.2 | V       | $I_{AA}=5mA$ ,<br>$V_{CSD}=V_{GND}$      |

**Electrical Characteristics (Cont'd)**

| Symbol   | Definition  | Min                                 | Typ                                    | Max                                 | Units | Test Conditions  |
|--|---|-------------------------------------|--|-------------------------------------|-------|--|
| <b>Audio Input</b> (GND=0V, V <sub>AA</sub> =5V, V <sub>SS</sub> =-5V, COM =V <sub>CC</sub> =-5V, V <sub>S1</sub> =V <sub>S2</sub> =CSH1=CSH2=-5V, DT=-5V) |   |                                     |  |                                     |       |  |
| V <sub>Osn</sub>   | CHn input offset voltage, n=1-2                         | -18                                 | 0                                      | 18                                  | mV    |  |
| I <sub>BIn</sub>   | CHn input bias current, n=1-2                           | -                                   | -                                      | 40                                  | nA    |  |
| GBW <sub>n</sub>   | CHn small signal bandwidth, n=1-2                       | -                                   | 5<br>Note 1                            | -                                   | MHz   | C <sub>COMPn</sub> =2.2nF,<br>R <sub>fn</sub> =10k, Note 1 |
| V <sub>COMPn</sub>   | CHn OTA Output voltage, n=1-2                           | V <sub>AA</sub> -1                  | -                                      | V <sub>SS</sub> +1                  | V     |  |
| g <sub>mn</sub>  | CHn OTA transconductance, n=1-2                         | 80                                  | 200                                    | 260                                 | mS    | V <sub>IN-n</sub> =10mV                                    |
| G <sub>Vn</sub>  | CHn OTA gain, n=1-2                                     | 60                                  | -                                      | -                                   | dB    |  |
| V <sub>Nrmsn</sub>   | CHn OTA input noise voltage, n=1-2                      | -                                   | 250                                    | -                                   | mVrms | BW=20kHz,<br>Resolution BW=22Hz<br>Fig.5                   |
| SR <sub>n</sub>  | CHn slew rate, n=1-2                                    | -                                   | ±5                                     | -                                   | V/us  | C <sub>COMPn</sub> =2.2nF                                  |
| CMRR <sub>n</sub>  | CHn common-mode rejection ratio, n=1-2                  | -                                   | 60                                     | -                                   | dB    |  |
| PSRR <sub>n</sub>  | CHn supply voltage rejection ratio, n=1-2               | -                                   | 65                                     | -                                   | dB    |  |
| <b>PWM Comparator</b>  |   |                                     |  |                                     |       |  |
| V <sub>thPWM</sub>   | PWM comparator threshold in COMP                        | -                                   | (V <sub>AA</sub> - V <sub>SS</sub> )/2 | -                                   | V     |  |
| f <sub>OTAn</sub>  | CHn COMP pin star-up local oscillation frequency, n=1-3 | -                                   | 0.6                                    | -                                   | MHz   | V <sub>CSD</sub> =V <sub>GND</sub> +2.5V                   |
| <b>Clock Input</b> (GND=0V, V <sub>AA</sub> =5V, V <sub>SS</sub> =-5V, COM =V <sub>CC</sub> =-5V, V <sub>S1</sub> =V <sub>S2</sub> =CSH1=CSH2=-5V, DT=-5V) |   |                                     |  |                                     |       |  |
| V <sub>IHCLK</sub>   | CLK high level input threshold                          | 8                                   |  | -                                   | V     |  |
| V <sub>ILCLK</sub>   | CLK low level input threshold                           | -                                   |  | 2                                   | V     |  |
| I <sub>IHCLK+</sub>  | CLK high level input bias current                       | -35                                 |  | 35                                  | μA    | V <sub>CLK</sub> =V <sub>AA</sub>                          |
| I <sub>ILCLK-</sub>  | CLK low level input bias current                        | -45                                 |  | 45                                  | μA    | V <sub>CLK</sub> =V <sub>SS</sub>                          |
| V <sub>THAB</sub>  | AB high level input threshold                           | 0.40x<br>(V <sub>AA</sub> -<br>GND) | 0.50x<br>(V <sub>AA</sub> -<br>GND)    | 0.60x<br>(V <sub>AA</sub> -<br>GND) | V     |  |
| I <sub>IHAB+</sub>   | AB high level input bias current                        | -35                                 |  | 35                                  | μA    | V <sub>AB</sub> =V <sub>AA</sub>                           |
| I <sub>ILAB-</sub>   | AB high level input bias current                        | -45                                 |  | 45                                  | μA    | V <sub>AB</sub> =GND                                       |
| <b>BTL Mode</b> (GND=0V, V <sub>AA</sub> =5V, V <sub>SS</sub> =-5V, COM =V <sub>CC</sub> =-5V, V <sub>S1</sub> =V <sub>S2</sub> =CSH1=CSH2=-5V, DT=-5V)    |   |                                     |  |                                     |       |  |
| V <sub>THBTL</sub>   | BTL high level input threshold                          | 0.40x<br>(V <sub>AA</sub> -<br>GND) | 0.50x<br>(V <sub>AA</sub> -<br>GND)    | 0.60x<br>(V <sub>AA</sub> -<br>GND) | V     |  |
| I <sub>IHBTL+</sub>  | BTL high level input bias current                       | -35                                 |  | 35                                  | μA    | V <sub>BTL</sub> =V <sub>AA</sub>                          |
| I <sub>ILBTL-</sub>  | BTL high level input bias current                       | -45                                 |  | 45                                  | μA    | V <sub>BTL</sub> =GND                                      |

**Electrical Characteristics (Cont'd)**

| Symbol              | Definition  | Min                      | Typ                      | Max                      | Units | Test Conditions                            |
|---------------------|---|--------------------------|--------------------------|--------------------------|-------|--|
| <b>Protection</b>   |   |                          |                          |                          |       |  |
| V <sub>thOCLn</sub> | CHn low side OC threshold in V <sub>CSLn</sub> , n=1-2  | 1.1                      | 1.2                      | 1.3                      | V     |  |
| V <sub>thOCHn</sub> | CHn high side OC threshold in V <sub>CSHn</sub> , n=1-2   | 1.1+ V <sub>s</sub>      | 1.2+ V <sub>s</sub>      | 1.3+ V <sub>s</sub>      | V     | V <sub>s</sub> =400V                       |
| V <sub>th1</sub>    | CSD pin shutdown release threshold  | 0.52xV <sub>AA-GND</sub> | 0.68xV <sub>AA-GND</sub> | 0.84xV <sub>AA-GND</sub> | V     |  |
| V <sub>th2</sub>    | CSD pin self reset threshold  | 0.26xV <sub>AA-GND</sub> | 0.30xV <sub>AA-GND</sub> | 0.34xV <sub>AA-GND</sub> | V     |  |
| I <sub>CSD+</sub>   | CSD pin discharge current   | 70                       | 100                      | 130                      | μA    | V <sub>CSD</sub> = V <sub>GND</sub> + 2.4V |
| I <sub>CSD-</sub>   | CSD pin charge current  | 70                       | 100                      | 130                      | μA    | V <sub>CSD</sub> = V <sub>GND</sub> + 2.4V |
| t <sub>SSDn</sub>   | CHn shutdown propagation delay from V <sub>CSD</sub> < V <sub>GND</sub> + V <sub>th1</sub> to Shutdown, n=1-2 | -                        | 140                      | 250                      | ns    |  |
| t <sub>OCHn</sub>   | CHn propagation delay time from V <sub>CSHn</sub> > V <sub>thOCHn</sub> to Shutdown, n=1-2                    | -                        | 400                      | 500                      | ns    |  |
| t <sub>OCLn</sub>   | CHn propagation delay time from V <sub>sn</sub> > V <sub>thOCL</sub> to Shutdown, n=1-2                       | -                        | 270                      | 350                      | ns    |  |
| V <sub>OTP</sub>    | OTP pin input threshold   | -                        | 2.8                      | -                        | V     |  |
| I <sub>OTP</sub>    | OTP bias sourcing current   | -                        | 0.6                      | -                        | mA    | OTPN=0V                                    |

**Electrical Characteristics (Cont'd)**

| Symbol             | Definition   | Min      | Typ      | Max      | Units | Test Conditions  |
|--------------------|--|----------|----------|----------|-------|--|
| <b>Gate Driver</b> |  |          |          |          |       |  |
| Io+n               | CHn output high short circuit current (Source) , n=1-2   | -        | 0.5      | -        | A     | Vo=0V, PW≤10μS, Note 1   |
| Io-n               | CHn output low short circuit current (Sink) , n=1-2  | -        | 0.6      | -        | A     | Vo=12V, PW≤10μS, Note 1  |
| VOLn               | CHn low level out put voltage LO – COM, HO - VS, n=1-2   | -        | -        | 0.1      | V     | Io=0A  |
| VOHn               | CHn high level out put voltage VCC – LO, VB - HO, n=1-2  | -        | -        | 1.4      | V     |  |
| Ton0n              | CHn high and low side turn-on propagation delay, n=1-2   | -        | 385      | -        | ns    | V <sub>DT</sub> = V <sub>CC</sub>  |
| Toff0n             | CHn high and low side turn-off propagation delay, n=1-2  | 270      | 340      | 410      | ns    |  |
| Toffskwn           | CHn Toff skew, Toffhon – Tofflon, n=1-2  | -30      | 0        | 30       | ns    |  |
| tr                 | Turn-on rise time  | -        | 12       | 25       | ns    |  |
| tf                 | Turn-off fall time   | -        | 12       | 25       | ns    |  |
| DT1n               | CHn deadtime: LOn turn-off to HOn turn-on (DT <sub>LO-HO</sub> ) & HOn turn-off to LnO turn-on (DT <sub>HO-LO</sub> )                                  | 30       | 45       | 65       | ns    | V <sub>DT</sub> >V <sub>DT1</sub> , V <sub>DTM</sub> =COM                    |
| DT2n               | CHn deadtime: LOn turn-off to HOn turn-on (DT <sub>LO-HO</sub> ) & HOn turn-off to LOn turn-on (DT <sub>HO-LO</sub> )                                  | 45       | 65       | 85       | ns    | V <sub>DT1</sub> >V <sub>DT</sub> > V <sub>DT2</sub> , V <sub>DTM</sub> =COM |
| DT3n               | CHn deadtime: LOn turn-off to HOn turn-on (DT <sub>LO-HO</sub> ) & HOn turn-off to LOn turn-on (DT <sub>HO-LO</sub> )                                  | 60       | 85       | 110      | ns    | V <sub>DT2</sub> >V <sub>DT</sub> > V <sub>DT3</sub> , V <sub>DTM</sub> =COM |
| DT4n               | CHn deadtime: LOn turn-off to HOn turn-on (DT <sub>LO-HO</sub> ) & HO turn-off to LOn turn-on (DT <sub>HO-LO</sub> )V <sub>DT</sub> = V <sub>DT4</sub> | 80       | 105      | 145      | ns    | V <sub>DT</sub> <V <sub>DT3</sub> , V <sub>DTM</sub> =COM                    |
| V <sub>DT1</sub>   | DT mode select threshold 1   | 0.51xVcc | 0.57xVcc | 0.63xVcc | V     | V <sub>DTM</sub> =COM  |
| V <sub>DT2</sub>   | DT mode select threshold 2   | 0.32xVcc | 0.36xVcc | 0.40xVcc | V     |  |
| V <sub>DT3</sub>   | DT mode select threshold 3   | 0.21xVcc | 0.23xVcc | 0.25xVcc | V     |  |

Note 1 Guaranteed by design, but not tested in production.

Waveform Definitions

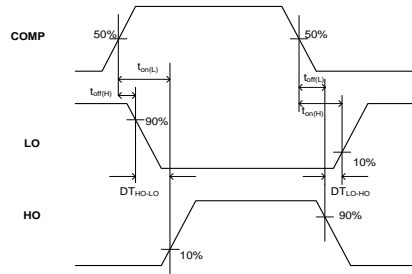


Figure 1 Switching Time Waveform Definitions

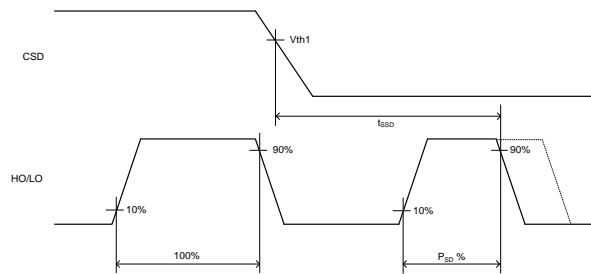


Figure 2 CSD to Shutdown Waveform Definitions

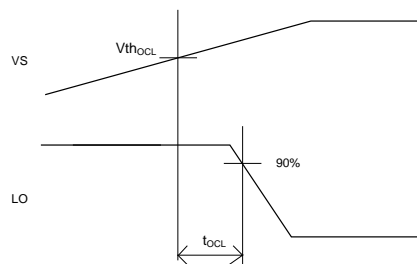
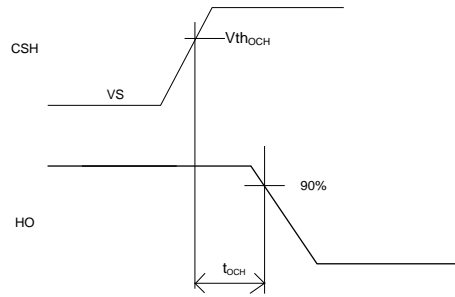


Figure 3  $V_S > V_{thOCL}$  to Shutdown Waveform



**Figure 4  $V_{CSH} > V_{thOCH}$  to Shutdown Waveform**

Waveform Definitions (Cont'd)

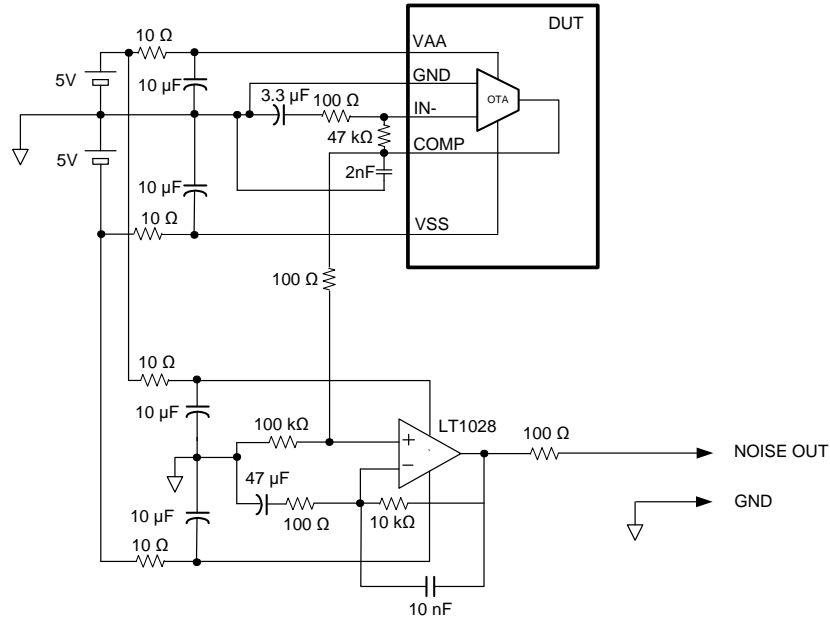
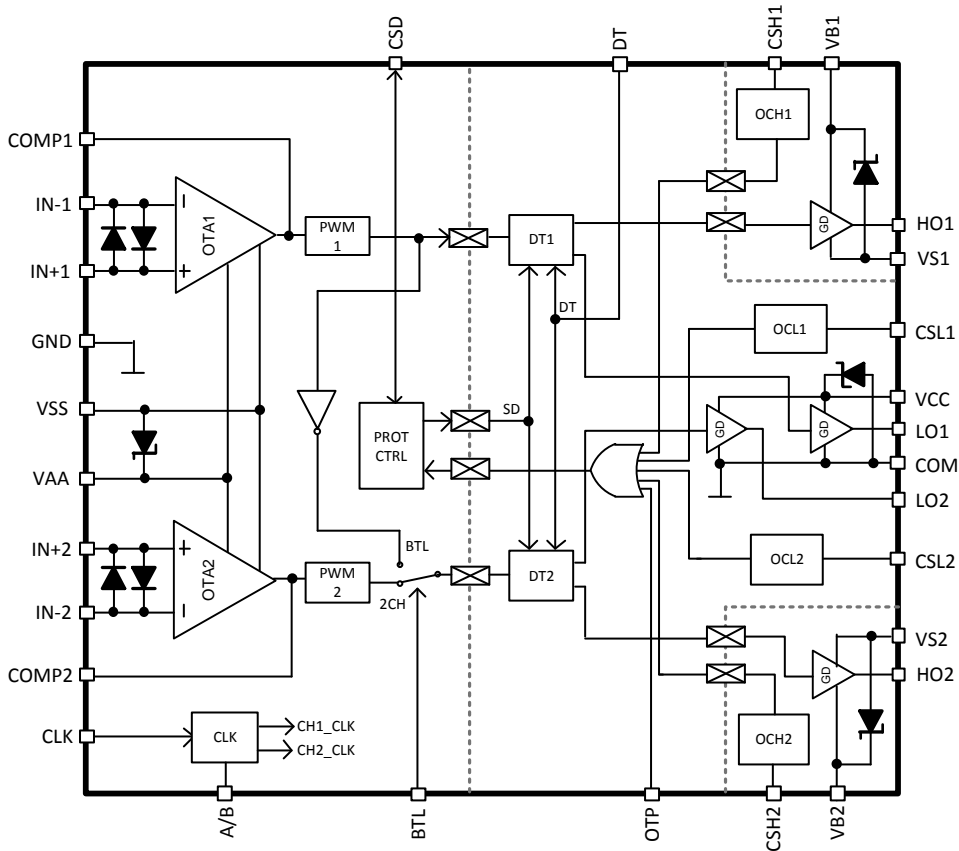
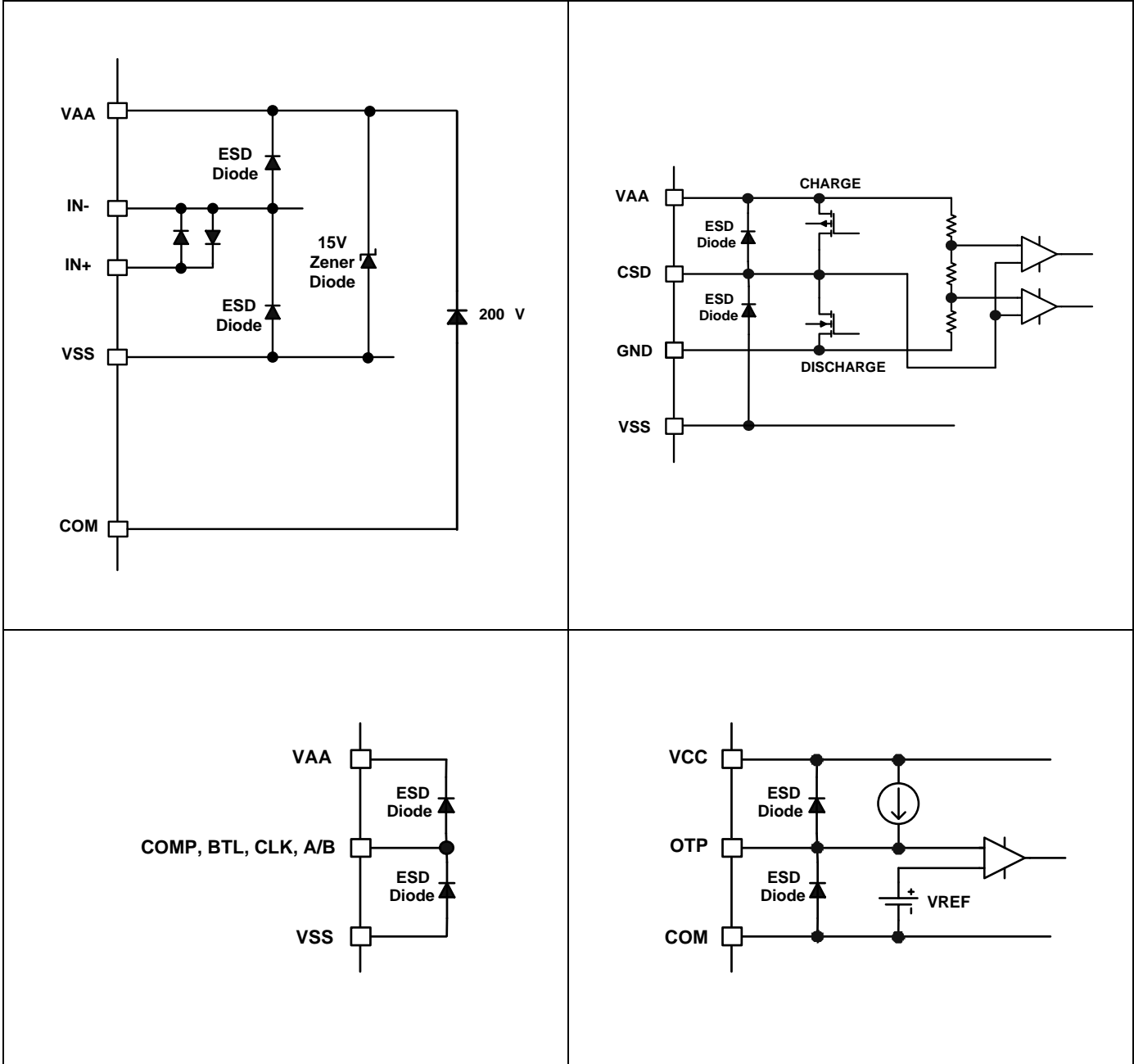


Figure 5: OTA input noise voltage mesurent circuit

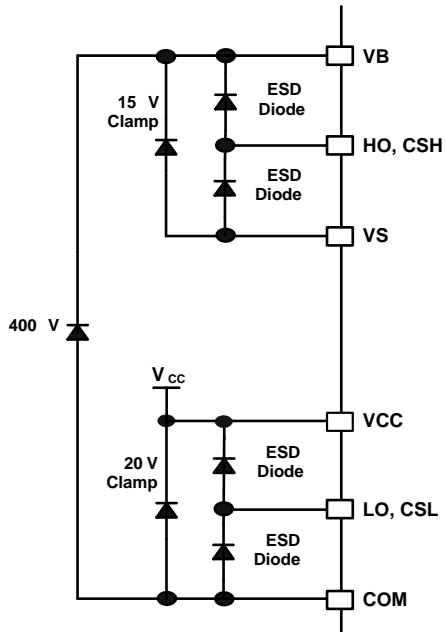
Functional Block Diagram



Input/Output Pin Equivalent Circuit Diagrams



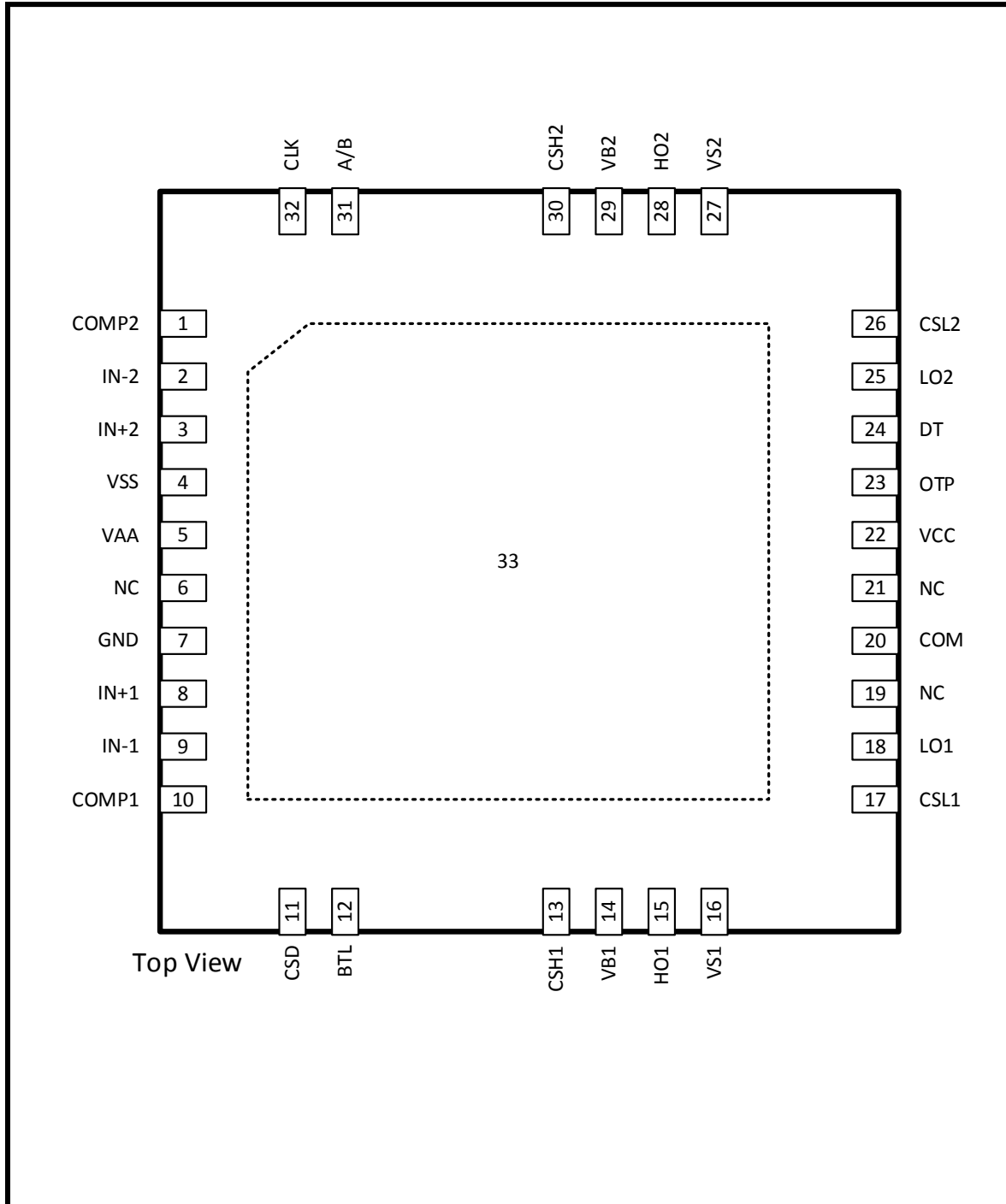
Input/Output Pin Equivalent Circuit Diagrams (Cont'd)



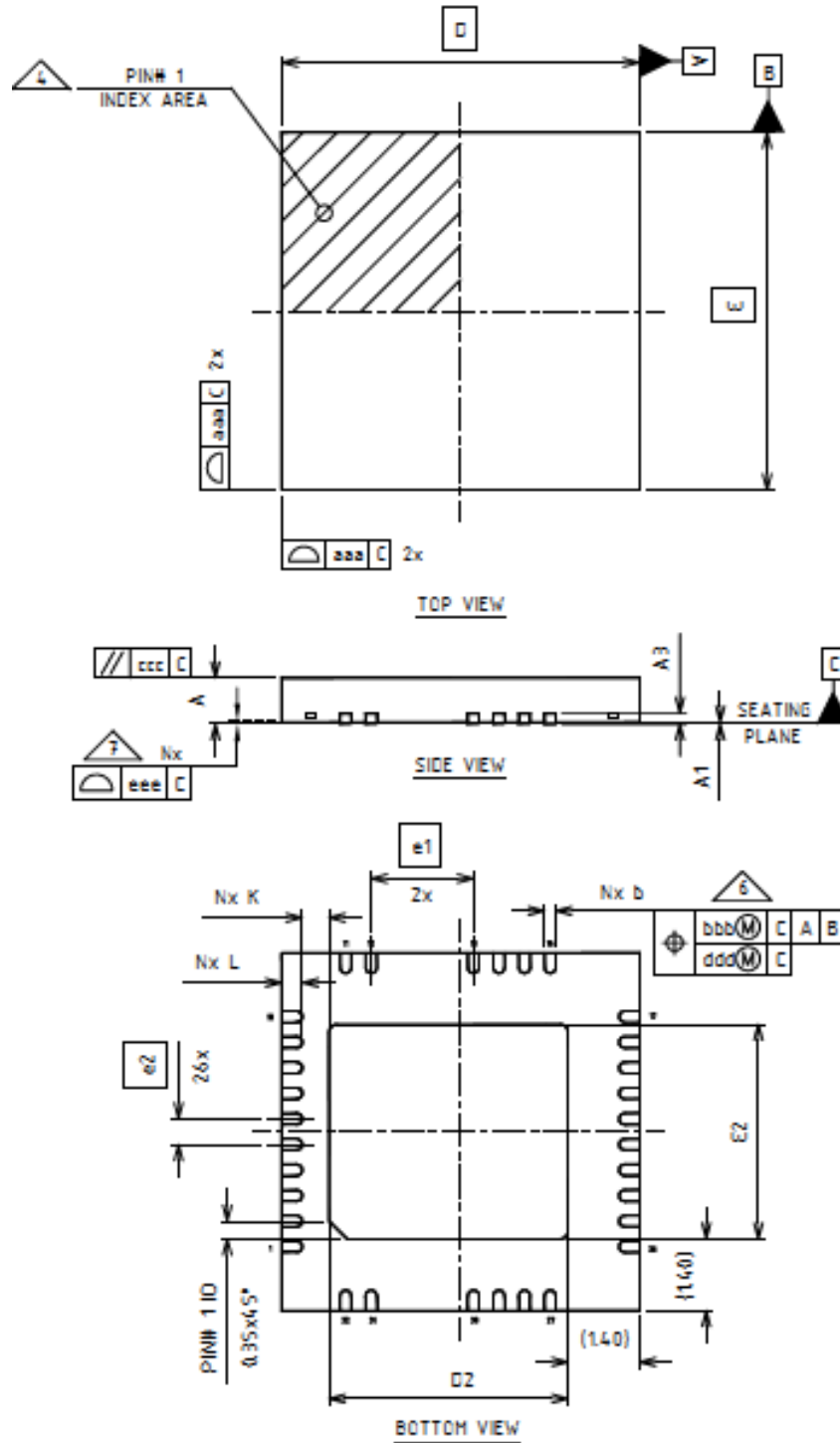
**Lead Definitions**

| Pin # | Symbol | I/O | Description   |
|-------|--------|-----|---|
| 1     | COMP2  | O   | CH2 PWM comparator input                                    |
| 2     | IN-2   | I   | CH2 inverting analog input                                  |
| 3     | IN+2   | I   | CH2 non-inverting analog input                              |
| 4     | VSS    | I   | Floating input negative supply                              |
| 5     | VAA    | I   | Floating input positive supply                              |
| 6     | NC     |     |   |
| 7     | GND    | I   | Input reference GND   |
| 8     | IN+1   | I   | CH1 non-inverting analog input                              |
| 9     | IN-1   | I   | CH1 inverting analog input                                  |
| 10    | COMP1  | O   | CH1 PWM comparator input                                    |
| 11    | CSD    | I/O | Protection control  |
| 12    | BTL    | I   | BTL mode select (VAA: 2CH mode, GND-VSS: BTL mode)          |
| 13    | CSH1   | I   | CH1 High side over current sensing input, referenced to VS1 |
| 14    | VB1    | I   | CH1 High side floating supply                               |
| 15    | HO1    | O   | CH1 High side output  |
| 16    | VS1    | I   | CH1 High side floating supply return                        |
| 17    | CSL1   | I   | CH1 Low side over current sensing input, referenced to COM  |
| 18    | LO1    | O   | CH1 Low side output   |
| 19    | NC     |     |   |
| 20    | COM    | I   | Low side gate drive supply return                           |
| 21    | NC     |     |   |
| 22    | VCC    | I   | Low side gate drive supply                                  |
| 23    | OTP    | I   | OTP sensor input  |
| 24    | DT     | I   | Deadtime program, reference to COM                          |
| 25    | LO2    | O   | CH2 Low side output   |
| 26    | CSL2   | I   | CH2 Low side over current sensing input, referenced to COM  |
| 27    | VS2    | I   | CH2 High side floating supply return                        |
| 28    | HO2    | O   | CH2 High side output  |
| 29    | VB2    | I   | CH2 High side floating supply                               |
| 30    | CSH2   | I   | CH2 High side over current sensing input, referenced to VS2 |
| 31    | A/B    | I   | Clock phase select (VAA: In-phase, VSS: Out-of-phase)       |
| 32    | CLK    | I   | Clock input, reference to GND                               |
| 33    | SUB    | I   | Internally connected to COM (Do not use as supply return)   |

## Lead Assignments (MLPQ\_7x7mm\_32L)






Package Details:

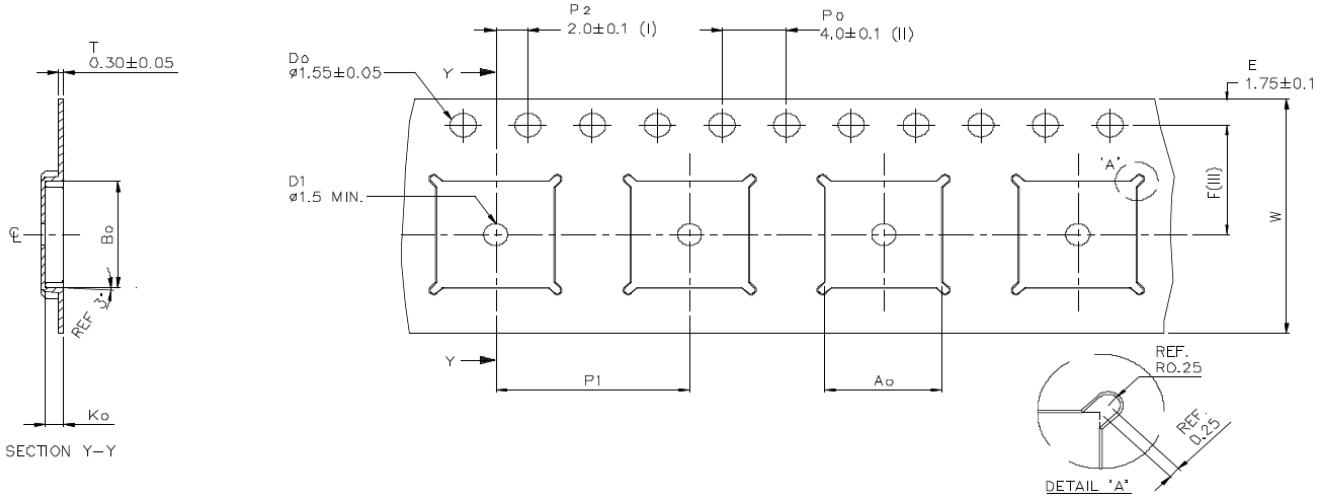


| Dimension Table     |          |           |         |      |
|---------------------|----------|-----------|---------|------|
| Thickness<br>Symbol | V        |           |         | NOTE |
|                     | MINIMUM  | NOMINAL   | MAXIMUM |      |
| A                   | 0.80     | 0.90      | 1.00    |      |
| A1                  | 0.00     | 0.02      | 0.05    |      |
| A3                  | ---      | 0.203 Ref | ---     |      |
| b                   | 0.18     | 0.25      | 0.30    | 6    |
| D                   | 7.00 BSC |           |         |      |
| E                   | 7.00 BSC |           |         |      |
| e1                  | 2.00 BSC |           |         |      |
| e2                  | 0.50 BSC |           |         |      |
| D2                  | 4.525    | 4.675     | 4.775   |      |
| E2                  | 4.05     | 4.20      | 4.30    |      |
| K                   | 0.20     | ---       | ---     |      |
| L                   | 0.30     | 0.40      | 0.50    |      |
| aaa                 | 0.05     |           |         |      |
| bbb                 | 0.10     |           |         |      |
| ccc                 | 0.10     |           |         |      |
| ddd                 | 0.05     |           |         |      |
| eee                 | 0.08     |           |         |      |
| N                   | 32       |           |         | 3    |
| ND                  | 6        |           |         | 5    |
| NE                  | 10       |           |         | 5    |
| NOTES               | 1, 2     |           |         |      |
| LF DWG NO.          | B-4396   |           |         |      |
| REV.                | 1        |           |         |      |

**NOTE:**

1. Dimensioning and tolerancing conform to ASME Y14.5-2009.
2. All dimensions are in millimeters.
3. N is the total number of terminals.
4.  The location of the marked terminal #1 identifier is within the hatched area.
5. ND and NE refer to the number of terminals on each D and E side respectively.
6.  Dimension b applies to metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip. If the terminal has a radius on the other end of it, dimension b should not be measured in that radius area.
7.  Coplanarity applies to the terminals and all other bottom surface metallization.

**Tape and Reel Details:**



|    |              |
|----|--------------|
| Ao | 7.25 +/−0.1  |
| Bo | 7.25 +/−0.1  |
| Ko | 1.10 +/−0.1  |
| F  | 7.50 +/−0.1  |
| P1 | 12.00 +/−0.1 |
| W  | 16.00 +/−0.3 |

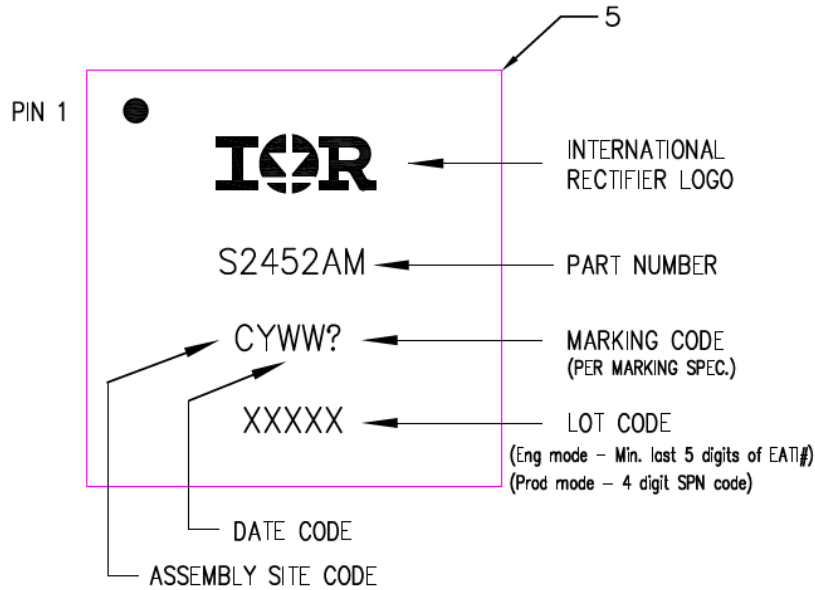
- (I) Measured from centreline of sprocket hole to centreline of pocket.
- (II) Cumulative tolerance of 10 sprocket holes is ± 0.20 .
- (III) Measured from centreline of sprocket hole to centreline of pocket.
- (IV) Other material available.
- (V) Typical SR of form tape Max 10<sup>9</sup> OHM/SQ

ALL DIMENSIONS IN MILLIMETRES UNLESS OTHERWISE STATED.

**Board Mounting Information**

Reliability of products in PQFN package is subject to board mounting process. Soldering process is critical. Refer to Application Note AN-1170 Audio Power Quad Flat No-Lead (PQFN) Board Mounting Application Note for specific soldering methods.

**Part Marking Information**



TOP MARKING (LASER)

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